

# SLG5NT1586V

An Ultra-small, 22.5 mΩ, 2.5 A Load Switch with Reverse Blocking

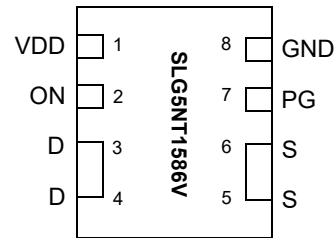
## General Description

The SLG5NT1586V is a 22.5 mΩ, 2.5 A single-channel load switch that is able to switch 1 V to 5 V power rails. The product is packaged in an ultra-small 1.0 x 1.6 mm package.

## Features

- 1.0 x 1.6 x 0.55 mm STDFN 8L package (2 fused pins for drain and 2 fused pins for source)
- Logic level ON pin capable of supporting 0.85 V CMOS Logic
- 22.5 mΩ RDS<sub>ON</sub> while supporting 2.5 A
- Power Good Output
- Pb-Free / Halogen-Free / RoHS compliant
- Operating Temperature: -40 °C to 85°C
- Operating Voltage: 1.5 V to 5.5 V

## Pin Configuration

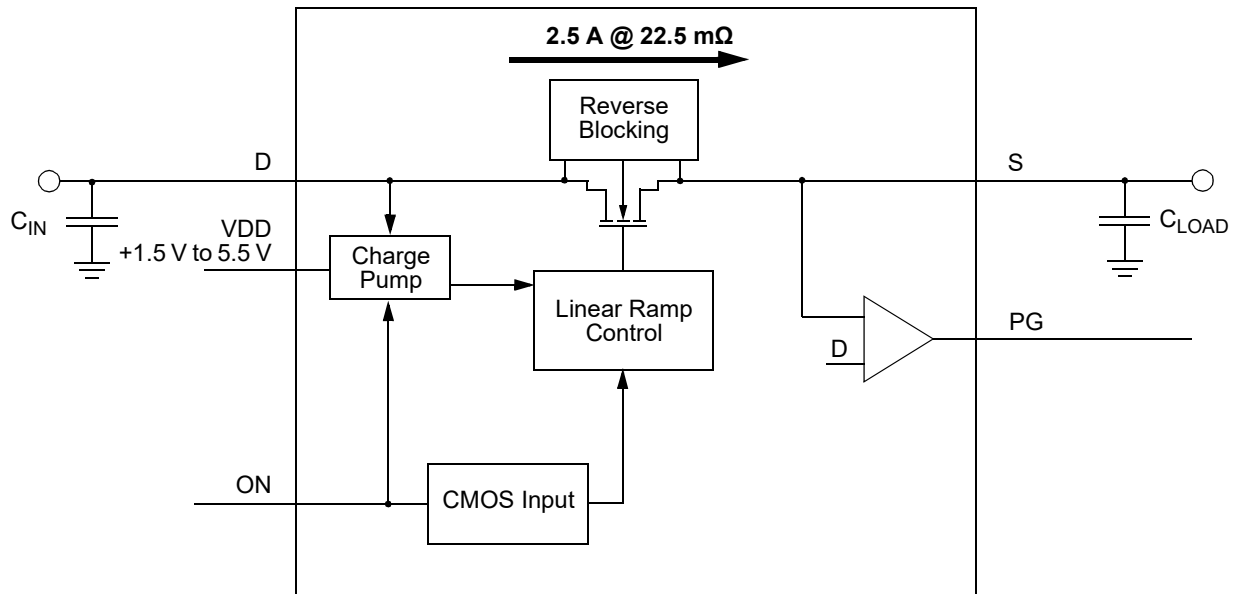


**8-pin FC-TDFN**  
(Top View)

## Applications

- Notebook Power Rail Switching
- Tablet Power Rail Switching
- Smartphone Power Rail Switching

## Block Diagram



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### Pin Description

Pin #	Pin Name	Type	Pin Description
1	VDD	Power	VDD supplies the power for the operation of the load switch and internal control circuitry. Bypass the VDD pin to GND with a 0.1 μF (or larger) capacitor.
2	ON	Input	A low-to-high transition on this pin initiates the operation of the SLG5NT1586V's state machine. ON is a CMOS input with ON_V <sub>IL</sub> < 0.3 V and ON_V <sub>IH</sub> > 0.85 V thresholds. While there is an internal pull-down circuit to GND (~4 MΩ), connect this pin directly to a general-purpose output (GPO) of a microcontroller, an application processor, or a system controller.
3, 4	D	MOSFET	Drain terminal connection of the n-channel MOSFET (2 pins fused for D). Connect at least a low-ESR 0.1 μF capacitor from this pin to ground. Capacitors used at D should be rated at 10 V or higher.
5, 6	S	MOSFET	Source terminal connection of the n-channel MOSFET (2 pins fused for S). Connect a low-ESR capacitor from this pin to ground and consult the Electrical Characteristics table for recommended C <sub>LOAD</sub> range. Capacitors used at S should be rated at 10 V or higher.
7	PG	Output	A push pull output. PG is asserted HIGH when V <sub>S</sub> > 95% of V <sub>D</sub> .
8	GND	GND	Ground connection. Connect this pin to system analog or power ground plane.

### Ordering Information

Part Number	Type	Production Flow
SLG5NT1586V	STDFN 8L	Industrial, -40 °C to 85 °C
SLG5NT1586VTR	STDFN 8L (Tape and Reel)	Industrial, -40 °C to 85 °C

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### Absolute Maximum Ratings

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V <sub>DD</sub>	Power Supply		--	--	7	V
T <sub>S</sub>	Storage Temperature		-65	--	150	°C
ESD <sub>HBM</sub>	ESD Protection	Human Body Model	2000	--	--	V
W <sub>DIS</sub>	Package Power Dissipation		--	--	0.4	W
MOSFET I <sub>DS(PK)</sub>	Peak Current from Drain to Source	For no more than 1 ms with 1% duty cycle	--	--	3.5	A

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### Electrical Characteristics

T<sub>A</sub> = -40 °C to 85 °C unless otherwise noted. Typical values are at T<sub>A</sub> = 25 °C, unless otherwise noted.

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V <sub>DD</sub>	Power Supply Voltage	-40 °C to 85 °C	1.5	--	5.5	V
I <sub>DD</sub>	Power Supply Current (PIN 1)	when OFF	--	--	1	μA
		when ON, No load	--	14	30	μA
RDS <sub>ON</sub>	ON Resistance	T <sub>A</sub> = 25 °C; I <sub>DS</sub> = 100 mA	--	22.5	25	mΩ
		T <sub>A</sub> = 85 °C; I <sub>DS</sub> = 100 mA	--	25.6	30	mΩ
MOSFET I <sub>DS</sub>	Current from D to S	Continuous	--	--	2.5	A
I <sub>REVERSE</sub>	MOSFET Reverse Leakage Current	V <sub>S</sub> = 1.0 V to 5.5 V, V <sub>D</sub> = 0 V, ON = 0 V; V <sub>DD</sub> = 1.5 V to 5.5 V; T <sub>A</sub> = 25 °C	--	0.04	0.55	μA
		V <sub>S</sub> = 1.0 V to 5.5 V, V <sub>D</sub> = 0 V, ON = 0 V V <sub>DD</sub> = 1.5 V to 5.5 V; T <sub>A</sub> = 85 °C	--	0.26	1.3	μA
		V <sub>S</sub> = 1.0 V to 5.5 V, V <sub>D</sub> = 0 V, ON = 0 V V <sub>DD</sub> = 1.5 V to 5.5 V; T <sub>A</sub> = -40 °C	--	0.31	9.70	μA
V <sub>D</sub>	Drain Voltage		1.0	--	V <sub>DD</sub>	V
T <sub>ON_Delay</sub>	ON Delay Time	50% ON to V <sub>S</sub> Ramp Start	--	300	500	μs
T <sub>Total_ON</sub>	Total Turn On Time	50% ON to 90% V <sub>S</sub> ; Example: V <sub>DD</sub> = V <sub>D</sub> = 5 V, C <sub>LOAD</sub> = 10 μF, R <sub>LOAD</sub> = 20 Ω	2.1	2.6	3.1	ms
V <sub>S(SR)</sub>	Slew Rate	10% V <sub>S</sub> to 90% V <sub>S</sub> ; Example: V <sub>DD</sub> = V <sub>D</sub> = 5 V, C <sub>LOAD</sub> = 10 μF, R <sub>LOAD</sub> = 20 Ω	1.4	1.95	2.2	V/ms
C <sub>LOAD</sub>	Output Load Capacitance	C <sub>LOAD</sub> connected from S to GND	--	--	500	μF
ON_V <sub>IH</sub>	High Input Voltage on ON pin		0.85	--	V <sub>DD</sub>	V
ON_V <sub>IL</sub>	Low Input Voltage on ON pin		-0.3	0	0.3	V
V <sub>OL</sub>	Low Output Voltage on PG pin	V <sub>DD</sub> = 5 V, I <sub>OL</sub> = -0.1 mA	--	--	0.4	V
V <sub>OH</sub>	High Output Voltage on PG pin	V <sub>DD</sub> = 5 V, I <sub>OH</sub> = 0.1 mA	V <sub>DD</sub> -0.4	--	V <sub>DD</sub>	V
THERM <sub>ON</sub>	Thermal shutoff turn-on temperature		--	125	--	°C
THERM <sub>OFF</sub>	Thermal shutoff turn-off temperature		--	100	--	°C
THERM <sub>TIME</sub>	Thermal shutoff time		--	--	1	ms
T <sub>OFF_Delay</sub>	OFF Delay Time	50% ON to V <sub>S</sub> Fall Start; V <sub>DD</sub> = V <sub>D</sub> = 5 V; R <sub>LOAD</sub> = 20 Ω; no C <sub>LOAD</sub>	--	8	--	μs

# SLG5NT1586V

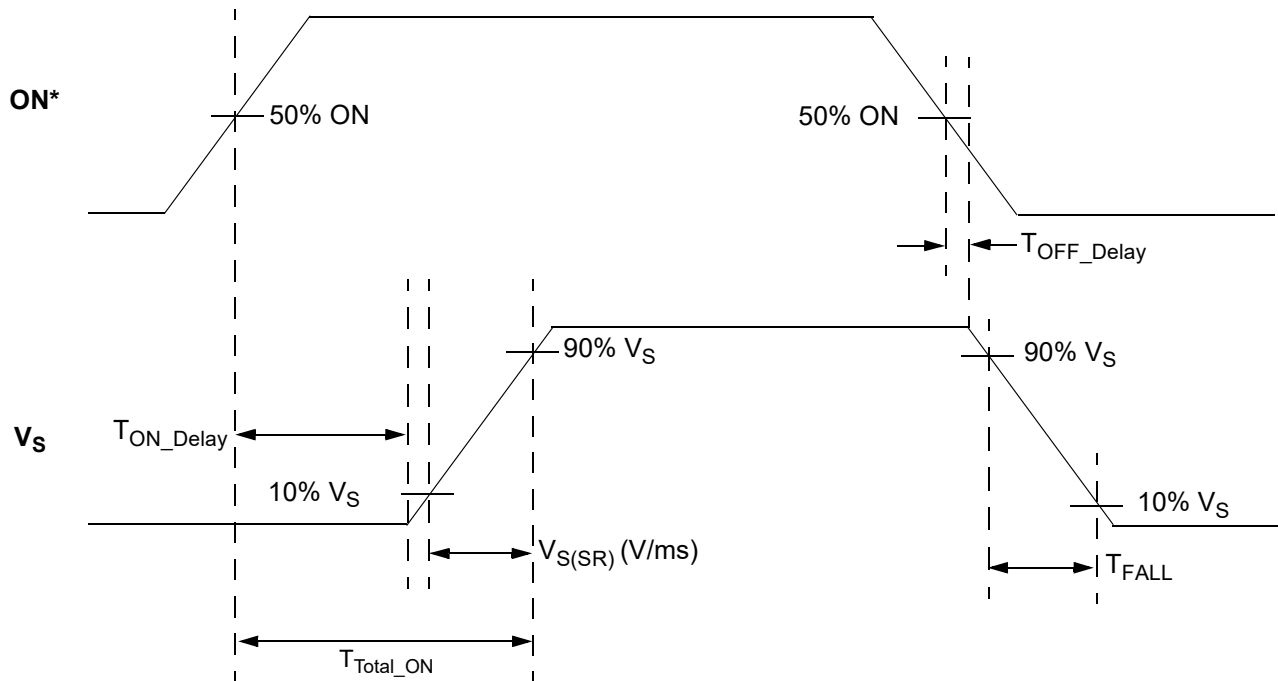
An Ultra-small, 22.5 mΩ, 2.5 A Load Switch with Reverse Blocking

## Electrical Characteristics (continued)

$T_A = -40\text{ }^\circ\text{C}$  to  $85\text{ }^\circ\text{C}$  unless otherwise noted. Typical values are at  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted.

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
PG <sub>TRIGGER</sub>	Power Good Trigger Level	$V_S$ % of $V_D$	--	95	--	%

## $T_{ON\_Delay}$ , $V_{S(SR)}$ , and $T_{Total\_ON}$ Timing Details



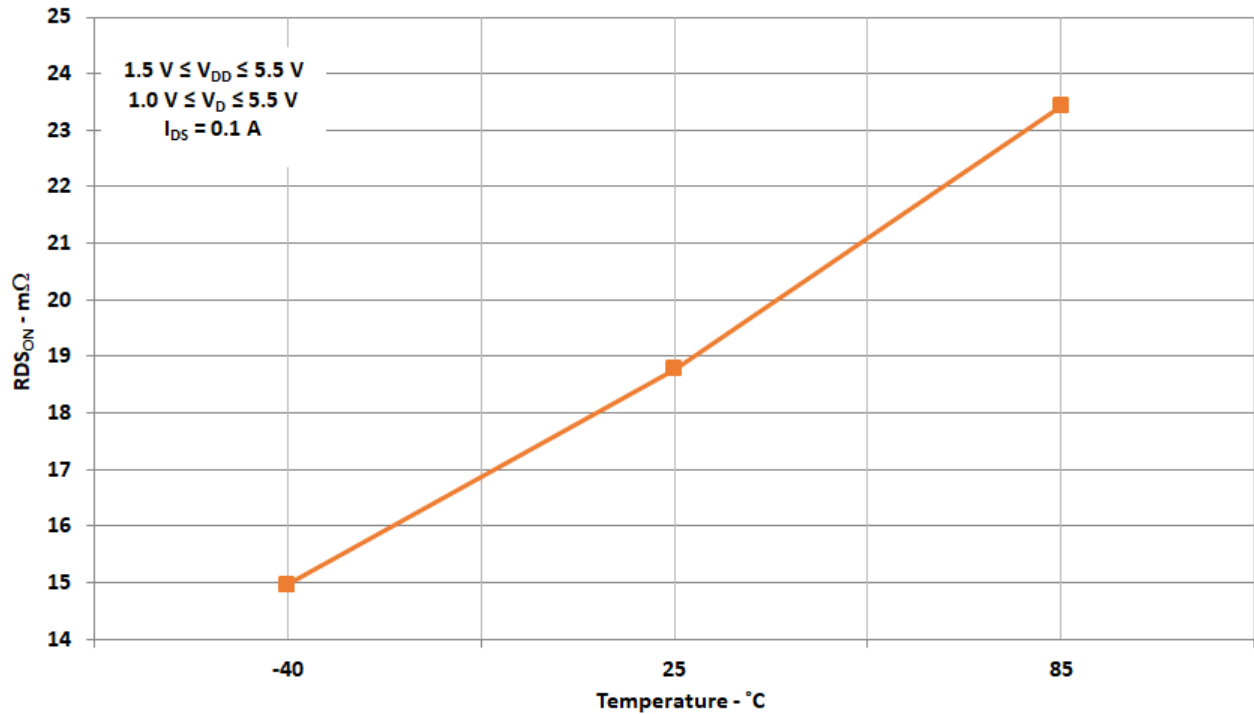
Note: \* Rise and Fall times of the ON signal are 100 ns

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### Typical Performance Characteristics

#### RDS<sub>ON</sub> vs. Temperature, V<sub>DD</sub>, and V<sub>IN</sub>



## SLG5NT1586V

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### SLG5NT1586V Power-Up/Power-Down Sequence Considerations

To ensure glitch-free power-up under all conditions, apply  $V_{DD}$  first, followed by  $V_D$  after  $V_{DD}$  exceeds 1 V. Then allow  $V_D$  to reach 90% of its max value before toggling the ON pin from Low-to-High. Likewise, power-down in reverse order.

If  $V_{DD}$  and  $V_D$  need to be powered up simultaneously, glitching can be minimized by having a suitable load capacitor. A 10  $\mu$ F  $C_{LOAD}$  will prevent glitches for rise times of  $V_{DD}$  and  $V_D$  higher than 2 ms.

If the ON pin is toggled HIGH before  $V_{DD}$  and  $V_D$  have reached their steady-state values, the load switch timing parameters may differ from datasheet specifications.

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#### Layout Guidelines:

1. The VDD pin needs a 0.1 μF and 10 μF external capacitors to smooth pulses from the power supply. Locate these capacitors as close as possible to the SLG5NT1586V's PIN1.
2. Since the D and S pins dissipate most of the heat generated during high-load current operation, it is highly recommended to make power traces as short, direct, and wide as possible. A good practice is to make power traces with absolute minimum widths of 15 mils (0.381 mm) per Ampere. A representative layout, shown in [Figure 1](#), illustrates proper techniques for heat to transfer as efficiently as possible out of the device;
3. To minimize the effects of parasitic trace inductance on normal operation, it is recommended to connect input C<sub>IN</sub> and output C<sub>LOAD</sub> low-ESR capacitors as close as possible to the SLG5NT1586V's D and S pins;
4. The GND pin should be connected to system analog or power ground plane.

#### SLG5NT1586V Evaluation Board:

A GreenFET Evaluation Board for SLG5NT1586V is designed according to the statements above and is illustrated on [Figure 1](#). Please note that evaluation board has D\_Sense and S\_Sense pads. They cannot carry high currents and dedicated only for RDS<sub>ON</sub> evaluation.

Please solder your SLG5NT1586V here

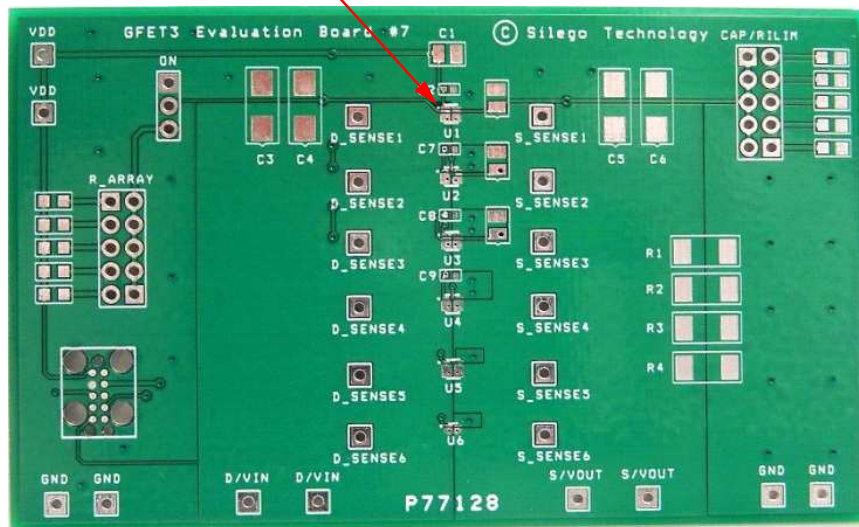


Figure 1. SLG5NT1586V Evaluation Board.

SLG5NT1586V

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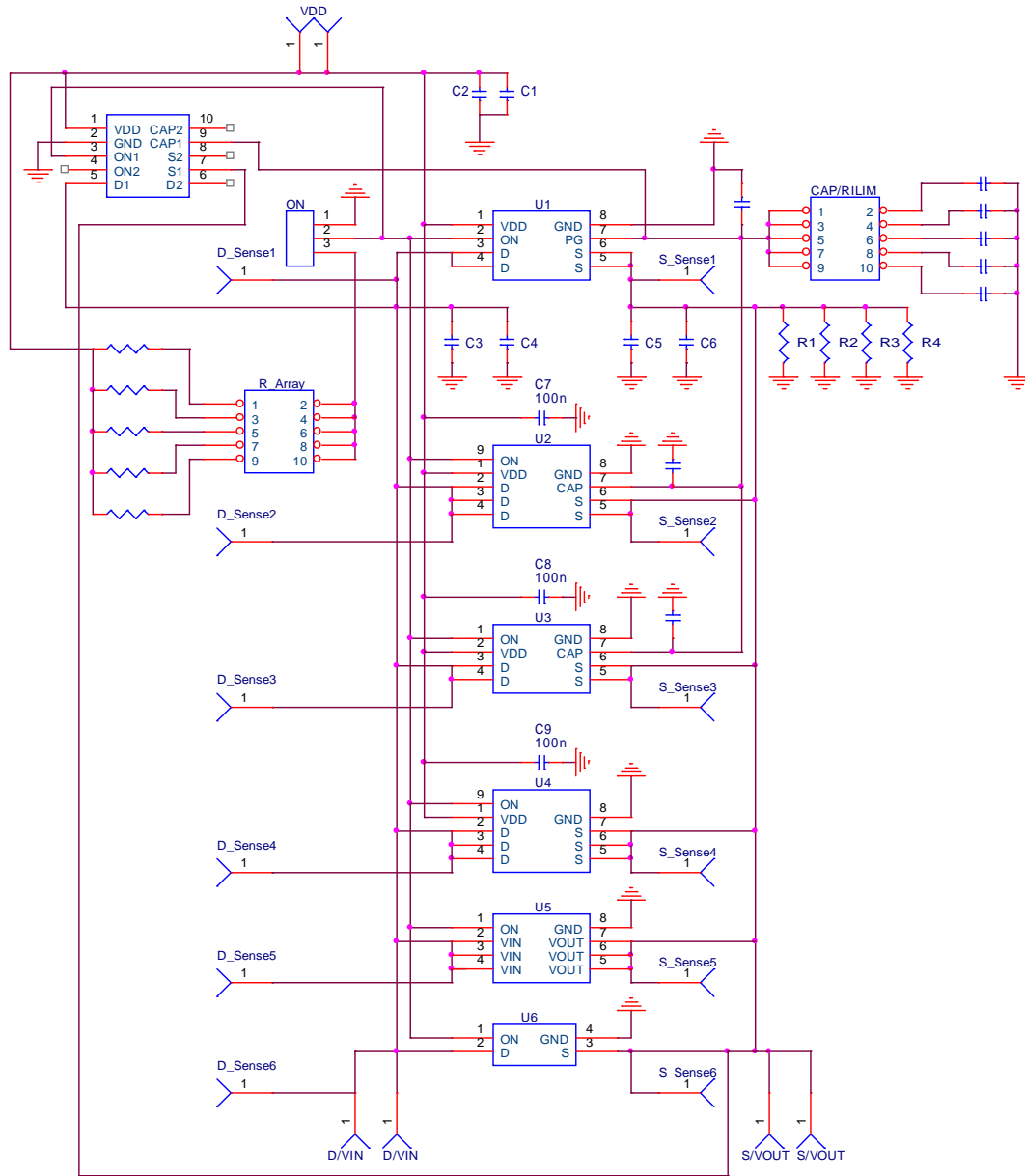


Figure 2. SLG5NT1586V Evaluation Board Connection Circuit.



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## Basic Test Setup and Connections

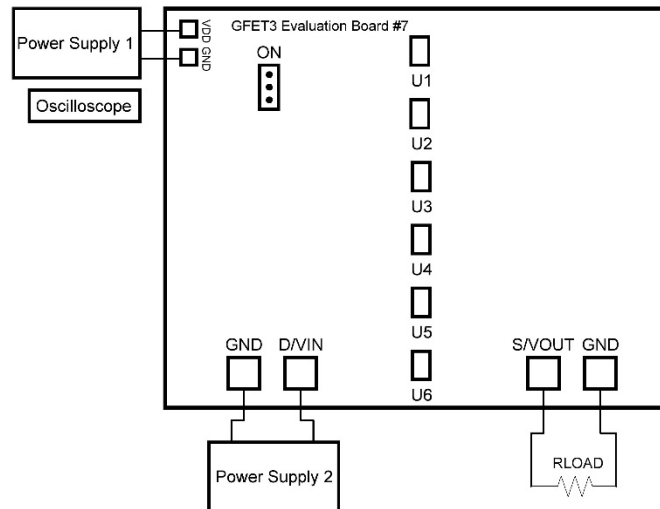


Figure 3. Typical connections for GreenFET Evaluation.

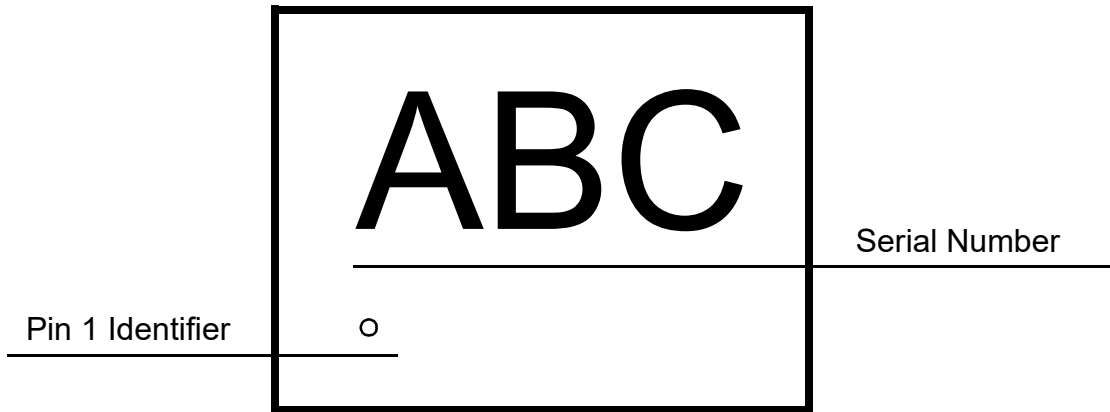
### EVB Configuration

1. Connect oscilloscope probes to D/VIN, S/VOUT, ON, etc.;
2. Turn on Power Supply 1 and set desired  $V_{DD}$  from 1.5 V...5.5 V range;
3. Turn on Power Supply 2 and set desired  $V_D$  from 1 V... $V_{DD}$  range;
4. Toggle the ON signal High or Low to observe SLG5NT1586V operation.

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**Package Top Marking System Definition**



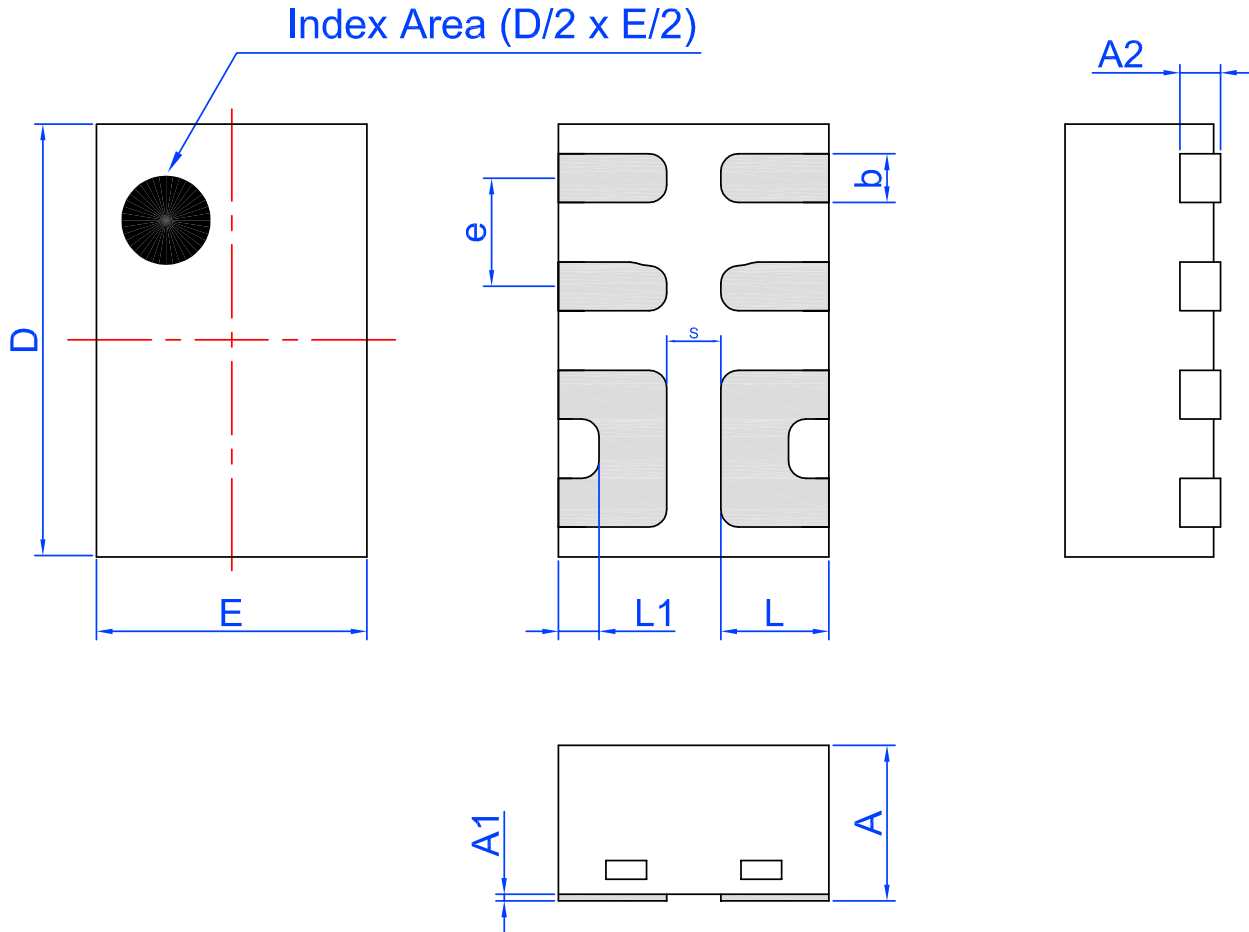
Each character in Serial Number field can be alphanumeric A-Z

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## Package Drawing and Dimensions

8 Lead STDFN Package 1.0 x 1.6 mm (Fused Lead)  
IC Net Weight: 0.0025 g



Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	1.55	1.60	1.65
A1	0.005	-	0.060	E	0.95	1.00	1.05
A2	0.10	0.15	0.20	L	0.35	0.40	0.45
b	0.13	0.18	0.23	L1	0.10	0.15	0.20
e	0.40 BSC			S	0.2 REF		

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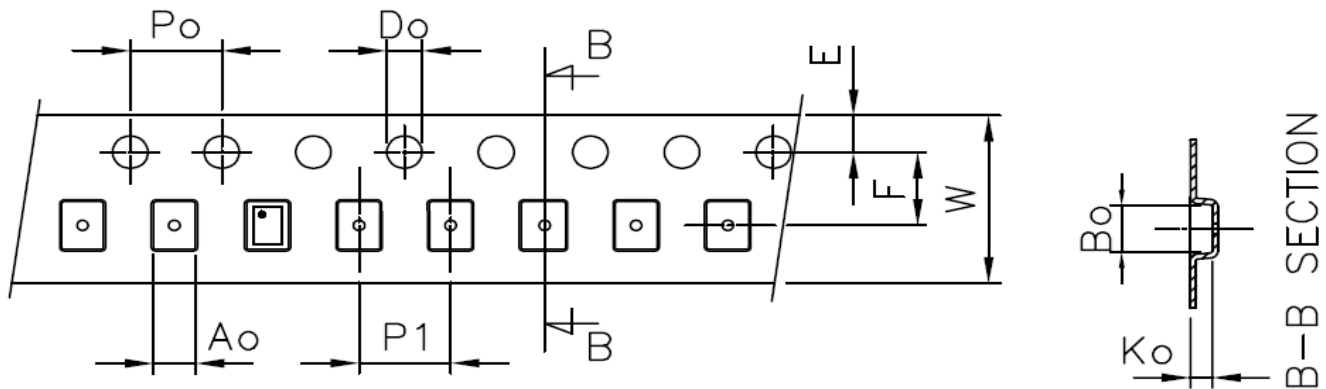
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### Tape and Reel Specifications

Package Type	# of Pins	Nominal Package Size [mm]	Max Units		Reel & Hub Size [mm]	Leader (min)		Trailer (min)		Tape Width [mm]	Part Pitch [mm]
			per Reel	per Box		Pockets	Length [mm]	Pockets	Length [mm]		
STDFN 8L 1x1.6mm 0.4P FC Green	8	1.0 x 1.6 x 0.55	3,000	3,000	178 / 60	100	400	100	400	8	4

### Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length	Pocket BTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge	Index Hole to Pocket Center	Tape Width
	A0	B0	K0	P0	P1	D0	E	F	W
STDFN 8L 1x1.6mm 0.4P FC Green	1.12	1.72	0.7	4	4	1.55	1.75	3.5	8



### Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 0.88 mm<sup>3</sup> (nominal). More information can be found at [www.jedec.org](http://www.jedec.org).

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### Revision History

Date	Version	Change
2/7/2022	1.03	Renesas rebranding Fixed typos
1/14/2019	1.02	Updated Style and formatting Added Chart Added Layout Guidelines Fixed typos
9/13/2016	1.01	Updated Power Up/Down Sequencing Considerations Updated Current Limiting Description Updated text and parameter names for clarity
03/01/2016	1.00	Production Release

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(Rev.1.0 Mar 2020)

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